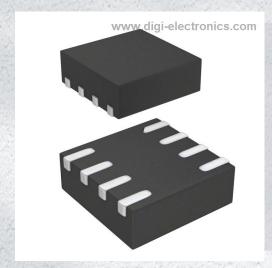


# 553SCMGI8 Datasheet



https://www.DiGi-Electronics.com

DiGi Electronics Part Number 553SCMGI8-DG

Manufacturer Renesas Electronics Corporation

Manufacturer Product Number 553SCMGI8

Description IC CLK BUFFER 1:4 200MHZ 8VFQFN

Detailed Description Clock Fanout Buffer (Distribution) IC 1:4 200 MHz 8-

UFDFN



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RFQ Email: Info@DiGi-Electronics.com

DiGi is a global authorized distributor of electronic components.



# **Purchase and inquiry**

Manufacturer Product Number:	Manufacturer:
553SCMGI8	Renesas Electronics Corporation
Series:	Product Status:
	Active
Type:	Number of Circuits:
Fanout Buffer (Distribution)	1
Ratio - Input:Output:	Differential - Input:Output:
1:4	No/No
Input:	Output:
Clock	Clock
Frequency - Max:	Voltage - Supply:
200 MHz	1.71V ~ 1.89V, 2.375V ~ 2.625V, 3.135V ~ 3.465V
Operating Temperature:	Mounting Type:
-40°C ~ 105°C (TA)	Surface Mount
Package / Case:	Supplier Device Package:
8-UFDFN	8-VFQFN (2x2)
Base Product Number:	
553S	

# **Environmental & Export classification**

RoHS Status:	Moisture Sensitivity Level (MSL):
ROHS3 Compliant	1 (Unlimited)
REACH Status:	ECCN:
REACH Unaffected	EAR99
HTSUS:	
8542.39.0001	



#### Low Skew 1 to 4 Clock Buffer

### **Description**

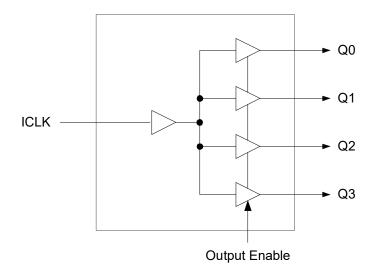
The 553S is a low skew, single input to four output, clock buffer. The 553S has best in class additive phase Jitter of sub 50 fsec.

Renesas makes many non-PLL and PLL based low skew output devices as well as Zero Delay Buffers to synchronize clocks. Contact Renesas for all of your clocking needs.

#### **Features**

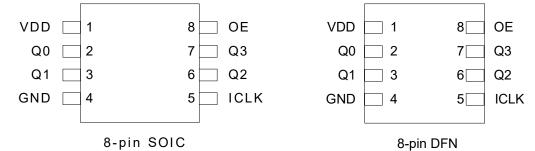
- · Low additive phase jitter RMS: 50fs
- Extremely low skew outputs (50ps)
- · Low cost clock buffer
- Packaged in 8-SOIC and small 8-DFN packages, Pb-free
- Input/Output clock frequency up to 200MHz
- · Ideal for networking clocks
- Operating voltages: 1.8V to 3.3V
- Output Enable mode tri-states outputs
- Advanced, low power CMOS process
- Extended temperature range (-40°C to +105°C)
- 3.3V tolerant input clock

#### **Block Diagram**





#### **Pin Assignments**



#### **Pin Descriptions**

Pin Number	Pin Name	Pin Type	Pin Description
1	VDD	Power	Connect to +1.8V, +2.5V, or +3.3V.
2	Q0	Output	Clock output 0.
3	Q1	Output	Clock output 1.
4	GND	Power	Connect to ground.
5	ICLK	Input	Clock input.
6	Q2	Output	Clock output 2.
7	Q3	Output	Clock output 3.
8	OE	Input	Output Enable. Tri-states outputs when low. Connect to VDD for normal operation.

### **External Components**

A minimum number of external components are required for proper operation. A decoupling capacitor of  $0.01\mu F$  should be connected between VDD on pin 1 and GND on pin 4, as close to the device as possible. A  $33\Omega$  series terminating resistor may be used on each clock output if the trace is longer than 1 inch.

To achieve the low output skew that the 553S is capable of, careful attention must be paid to board layout. Essentially, all four outputs must have identical terminations, identical loads and identical trace geometries. If they do not, the output skew will be degraded. For example, using a  $30\Omega$  series termination on one output (with  $33\Omega$  on the others) will cause at least 15ps of skew.



### **Absolute Maximum Ratings**

Stresses above the ratings listed below can cause permanent damage to the 553S. These ratings, which are standard values for Renesas commercially rated parts, are stress ratings only. Functional operation of the device at these or any other conditions above those indicated in the operational sections of the specifications is not implied. Exposure to absolute maximum rating conditions for extended periods can affect product reliability. Electrical parameters are guaranteed only over the recommended operating temperature range.

Item	Rating
Supply Voltage, VDD	3.8V
Output Enable and All Outputs	-0.5 V to VDD + 0.5 V
ICLK	3.465V
Ambient Operating Temperature (extended)	-40 to +105°C
Storage Temperature	-65 to +150°C
Junction Temperature	125°C
Soldering Temperature	260°C
Input ESD Protection (Human Body Model)	2500V

### **Recommended Operation Conditions**

Parameter	Min.	Тур.	Max.	Unit
Ambient Operating Temperature (extended)	-40	-	+105	°C
Power Supply Voltage (measured in respect to GND)	+1.71	-	+3.465	V



### **DC Electrical Characteristics**

(VDD = 1.8V, 2.5V, 3.3V)

 $V_{DD}$  = 1.8V ±5%, Ambient temperature -40° to +105°C, unless stated otherwise

Parameter	Symbol	Conditions	Min.	Тур.	Max.	Unit
Operating Voltage	VDD		1.71	-	1.89	V
Input High Voltage, ICLK	V <sub>IH</sub>	Note 1	0.7xVDD	-	3.45	V
Input Low Voltage, ICLK	V <sub>IL</sub>	Note 1	-	-	0.3xVDD	V
Input High Voltage, OE	V <sub>IH</sub>		0.7xVDD	-	VDD	V
Input Low Voltage, OE	V <sub>IL</sub>		-	-	0.3xVDD	V
Output High Voltage	V <sub>OH</sub>	I <sub>OH</sub> = -10mA	1.3	-	-	V
Output Low Voltage	V <sub>OL</sub>	I <sub>OL</sub> = 10mA	-	-	0.35	V
Operating Supply Current	IDD	No load, 135MHz	-	15	-	mA
Nominal Output Impedance	Z <sub>O</sub>		-	17	-	Ω
Input Capacitance	C <sub>IN</sub>	ICLK, OE pin	-	5	-	pF

Notes: 1. Nominal switching threshold is VDD/2.

 $V_{DD}$  = 2.5 V ±5%, Ambient temperature -40° to +105°C, unless stated otherwise

Parameter	Symbol	Conditions	Min.	Тур.	Max.	Unit
Operating Voltage	VDD		2.375	-	2.625	V
Input High Voltage, ICLK	V <sub>IH</sub>	Note 1	0.7xVDD	-	3.45	V
Input Low Voltage, ICLK	V <sub>IL</sub>	Note 1	-	-	0.3xVDD	V
Input High Voltage, OE	V <sub>IH</sub>		0.7xVDD	-	VDD	V
Input Low Voltage, OE	V <sub>IL</sub>		-	-	0.3xVDD	V
Output High Voltage	V <sub>OH</sub>	I <sub>OH</sub> = -16mA	1.8	-	-	V
Output Low Voltage	V <sub>OL</sub>	I <sub>OL</sub> = 16mA	-	-	0.5	V
Operating Supply Current	IDD	No load, 135MHz	-	18	-	mA
Nominal Output Impedance	Z <sub>O</sub>		-	17	-	Ω
Input Capacitance	C <sub>IN</sub>	ICLK, OE pin	-	5	-	pF

Notes: 1. Nominal switching threshold is VDD/2.

 $V_{DD}$  = 3.3 V ±5%, Ambient temperature -40° to +105°C, unless stated otherwise

Parameter	Symbol	Conditions	Min.	Тур.	Max.	Unit
Operating Voltage	VDD		3.135	-	3.465	V
Input High Voltage, ICLK	V <sub>IH</sub>	Note 1	0.7xVDD	-	3.45	V
Input Low Voltage, ICLK	$V_{IL}$	Note 1	-	-	0.3xVDD	V
Input High Voltage, OE	V <sub>IH</sub>		0.7xVDD	-	VDD	V
Input Low Voltage, OE	V <sub>IL</sub>		-	-	0.3xVDD	V
Output High Voltage	V <sub>OH</sub>	I <sub>OH</sub> = -25mA	2.2	-	-	V
Output Low Voltage	V <sub>OL</sub>	I <sub>OL</sub> = 25mA	-	-	0.7	V
Operating Supply Current	IDD	No load, 135MHz	-	22	-	mA
Nominal Output Impedance	Z <sub>O</sub>		-	17	-	Ω
Input Capacitance	C <sub>IN</sub>	ICLK, OE pin	-	5	-	pF

Notes: 1. Nominal switching threshold is VDD/2.



#### **AC Electrical Characteristics**

(VDD = 1.8V, 2.5V, 3.3V)

 $V_{DD}$  = 1.8V ±5%, Ambient Temperature -40° to +105°C, unless stated otherwise

Parameter	Symbol	Conditions	Min.	Тур.	Max.	Unit
Input Frequency			0	-	200	MHz
Output Rise Time	t <sub>OR</sub>	0.36 to 1.44V, C <sub>L</sub> = 5pF	-	0.6	1.0	ns
Output Fall Time	t <sub>OF</sub>	1.44 to 0.36V, C <sub>L</sub> = 5pF	-	0.6	1.0	ns
Propagation Delay	Note 1		2.5	3	3.5	ns
Buffer Additive Phase Jitter, RMS		125MHz, Integration Range: 12kHz–20MHz	-	-	0.05	ps
Output to Output Skew	Note 2	Rising edges at VDD/2	-	50	65	ps
Device to Device Skew		Rising edges at VDD/2	-	-	200	ps
Start-up Time	t <sub>START-UP</sub>	Part start-up time for valid outputs after VDD ramp-up	-	-	2	ms
Output Enable Time	t <sub>EN</sub>	C <sub>L</sub> ≤ 5pF	-	-	3	cycles
Output Disable Time	t <sub>DIS</sub>	C <sub>L</sub> ≤ 5pF	-	-	3	cycles

### $V_{DD}$ = 2.5 V ±5%, Ambient Temperature -40° to +105°C, unless stated otherwise

Parameter	Symbol	Conditions	Min.	Тур.	Max.	Unit
Input Frequency			0	-	200	MHz
Output Rise Time	t <sub>OR</sub>	0.5 to 2.0 V, C <sub>L</sub> = 5pF	-	0.6	1.0	ns
Output Fall Time	t <sub>OF</sub>	2.0 to 0.5 V, C <sub>L</sub> = 5pF	-	0.6	1.0	ns
Propagation Delay	Note 1		3	3.5	4	ns
Buffer Additive Phase Jitter, RMS		125MHz, Integration Range: 12kHz–20MHz	-	_	0.05	ps
Output to Output Skew	Note 2	Rising edges at VDD/2	-	40	65	ps
Device to Device Skew		Rising edges at VDD/2	-	-	200	ps
Start-up Time	t <sub>START-UP</sub>	Part start-up time for valid outputs after VDD ramp-up	-	-	2	ms
Output Enable Time	t <sub>EN</sub>	C <sub>L</sub> ≤ 5pF	-	_	3	cycles
Output Disable Time	t <sub>DIS</sub>	C <sub>L</sub> ≤ 5pF	-	_	3	cycles

 $V_{DD}$  = 3.3 V ±5%, Ambient Temperature -40° to +105°C, unless stated otherwise

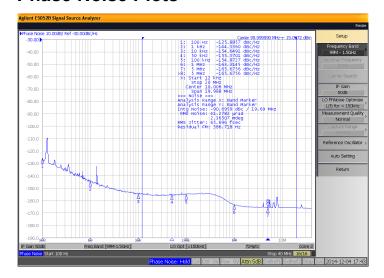
Parameter	Symbol	Conditions	Min.	Тур.	Max.	Unit
Input Frequency			0	-	200	MHz
Output Rise Time	t <sub>OR</sub>	0.66 to 2.64 V, C <sub>L</sub> = 5pF	-	0.6	1.0	ns
Output Fall Time	t <sub>OF</sub>	2.64 to 0.66 V, C <sub>L</sub> = 5pF	-	0.6	1.0	ns
Propagation Delay	Note 1		2.5	3	3.5	ns
Buffer Additive Phase Jitter, RMS		125MHz, Integration Range: 12kHz–20MHz	-	-	0.05	ps
Output to Output Skew	Note 2	Rising edges at VDD/2	-	25	65	ps
Device to Device Skew		Rising edges at VDD/2	-	-	200	ps
Start-up Time	t <sub>START-UP</sub>	Part start-up time for valid outputs after VDD ramp-up	-	-	2	ms
Output Enable Time	t <sub>EN</sub>	C <sub>L</sub> ≤ 5pF	-	-	3	cycles
Output Disable Time	t <sub>DIS</sub>	C <sub>L</sub> ≤5pF	-	-	3	cycles

#### Notes:

- 1. With rail to rail input clock.
- 2. Between any 2 outputs with equal loading.
- 3. Duty cycle on outputs will match incoming clock duty cycle. Consult Renesas for tight duty cycle clock generators.



#### **Phase Noise Plots**



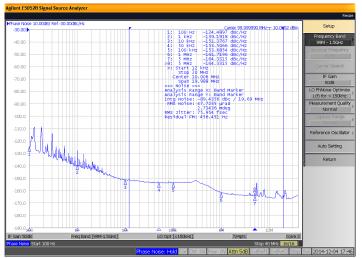
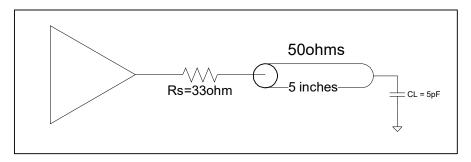


Figure 1. 553S Reference Phase Noise 66fs (12kHz to 20MHz)

Figure 2. 553S Output Phase Noise 76fs (12kHz to 20MHz)

The phase noise plots above show the low Additive Jitter of the 553S high-performance buffer. With an integration range of 12kHz to 20MHz, the reference input has about 66fs of RMS phase jitter while the output of 553S has about 76fs of RMS phase jitter. This results in a low Additive Phase Jitter of only 37fs.

#### **Test Load and Circuit**

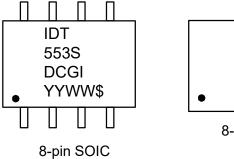


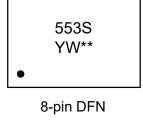


### Thermal Characteristics (8SOIC)

Parameter	Symbol	Conditions	Min.	Тур.	Max.	Unit
Thermal Resistance Junction to Ambient	$\theta_{JA}$	Still air	-	150	-	°C/W
	$\theta_{JA}$	1 m/s air flow	-	140	-	°C/W
	$\theta_{JA}$	3 m/s air flow	-	120	-	°C/W
Thermal Resistance Junction to Case	θ <sub>JC</sub>		-	40	-	°C/W

### **Marking Diagrams**





#### Notes:

- 1. "\*\*" is the lot number.
- 2. "YYWW" or "YW" are the last digits of the year and week that the part was assembled.
- 3 "G" denotes RoHS compliant package.
- 4. "\$" denotes mark code.
- 5. "I" denotes extended temperature range device.

### **Package Outline Drawings**

The package outline drawings are appended at the end of this document and are accessible from the links below. The package information is the most current data available.

### **Ordering Information**

Part Number	Shipping Packaging	Package	Temperature Range
553SDCGI	Tubes	8-pin SOIC	-40°C to +105°C
553SDCGI8	Tape and Reel	8-pin SOIC	-40°C to +105°C
553SCMGI	Cut Tape	8-pin DFN	-40°C to +105°C
553SCMGI8	Tape and Reel	8-pin DFN	-40°C to +105°C

<sup>&</sup>quot;G" after the two-letter package code denotes Pb-Free configuration, RoHS compliant.



# **Revision History**

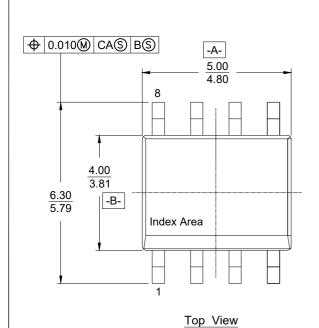
Date	Description of Change	
December 13, 2023	Update POD link to the latest drawing for 8-DFN (CMG8D1).	
September 29, 2023	Changed "Input High Voltage, ICLK" maximum parameter in DC Electrical Characteristics 3.3V table to 3.45V from VDD.	
February 3, 2023	Updated package drawings links in Package Outline Drawings.	
January 6, 2020	Added "Input ESD Protection" information in Absolute Maximum Ratings table.	
October 5, 2018	Added "3.3V tolerant input clock" bullet to Features section.	
	Updated voltage ratings in DC Electrical Characteristics tables.	
	Updated Package Outline Drawings section.	
	Updated legal disclaimer.	
March 18, 2015	Initial release.	

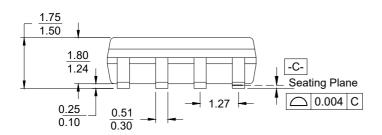
### **Package Outline Drawing**

Package Code: DCG8D1

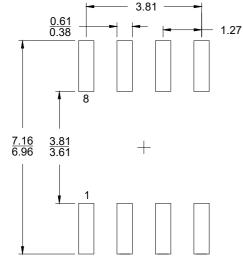
8-SOIC 4.82 x 3.81 x 1.72 mm Body, 1.27mm Pitch PSC-4068-01, Revision: 02, Date Created: Jun 21, 2022



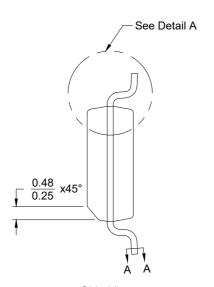




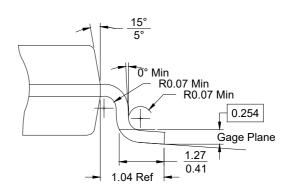
Side View



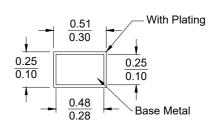
RECOMMENDED LAND PATTERN (PCB Top View, SMD Design)



Side View



Detail A (Rotated 90° CW)



Section A-A

#### NOTES:

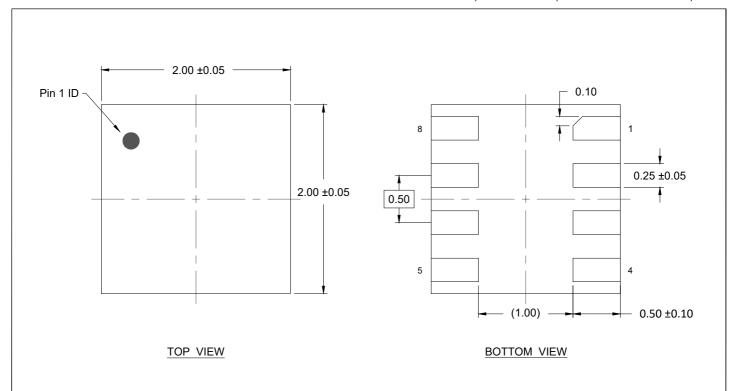
- 1. JEDEC compatible.
- 2. All dimensions are in mm and angles are in degrees.
- 3. Use ±0.05 mm for the non-toleranced dimensions.
- Foot length is measured at gauge plane 0.25 mm above seating plane.

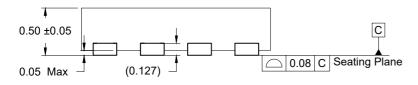




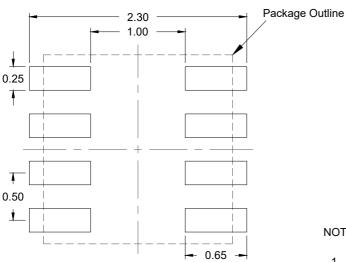
Package Code: CMG8D1 8-DFN 2.0 x 2.0 x 0.5 mm Body, 0.5mm Pitch

PSC-4490-01, Revision: 00, Date Created: Oct 05, 2023





SIDE VIEW



### RECOMMENDED LAND PATTERN

(PCB Top View, NSMD Design)

#### NOTES:

- JEDEC compatible.
- All dimensions are in mm and angles are in degrees. 2.
- Use ±0.05 mm for the non-toleranced dimensions.
- Numbers in ( ) are for references only.

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